

ABSTRACT

An object of the present disclosure is to provide a composition containing a modified polyacetal suitable for applications of inorganic powder injection molding. A composition for inorganic powder injection molding of the present disclosure includes a sinterable inorganic powder and an organic binder containing a modified polyacetal (C) including a polyacetal segment (A) and a modification segment (B), wherein the number average molecular weight of the above modification segment (B) is 500 to 10000.

10

[No figure]